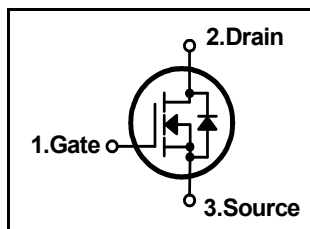


**N-Channel MOSFET****N-Channel MOSFET****Features**

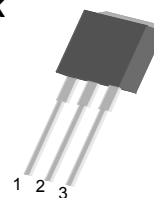
- **High ruggedness**
- $R_{DS(on)}$  (Max 11.5  $\Omega$ )@ $V_{GS}=10V$
- Gate Charge (Typical 7nC)
- Improved dv/dt Capability
- 100% Avalanche Tested



$BV_{DSS} = 600V$   
 $R_{DS(ON)} = 11.5 \text{ ohm}$   
 $I_D = 1.0A$

**General Description**

This N-channel enhancement mode field-effect power transistor using DI semiconductor's advanced planar stripe, DMOS technology intended for off-line switch mode power supply. Also, especially designed to minimize  $r_{ds(on)}$  and high rugged avalanche characteristics. The I-PAK pkg is well suited for charger SMPS and small power inverter application.

**I-PAK****Absolute Maximum Ratings**

Symbol	Parameter	Value	Units
$V_{DSS}$	Drain to Source Voltage	600	V
$I_D$	Continuous Drain Current(@ $T_C = 25^\circ C$ )	1.0	A
	Continuous Drain Current(@ $T_C = 100^\circ C$ )	0.65	A
$I_{DM}$	Drain Current Pulsed (Note 1)	4.0	A
$V_{GS}$	Gate to Source Voltage	$\pm 30$	V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	52	mJ
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	3.0	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.5	V/ns
$P_D$	Total Power Dissipation(@ $T_C = 25^\circ C$ )	30	W
	Derating Factor above 25 $^\circ C$	0.23	W/ $^\circ C$
$T_{STG}, T_J$	Operating Junction Temperature & Storage Temperature	- 55 ~ 150	$^\circ C$
$T_L$	Maximum Lead Temperature for soldering purpose, 1/8 from Case for 5 seconds.	300	$^\circ C$

**Thermal Characteristics**

Symbol	Parameter	Value			Units
		Min.	Typ.	Max.	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	-	-	4.2	$^\circ C/W$
$R_{\theta CS}$	Thermal Resistance, Case to Sink	-	-	50	$^\circ C/W$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	-	-	110	$^\circ C/W$

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## Electrical Characteristics (T<sub>C</sub> = 25 °C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250uA	600	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature coefficient	I <sub>D</sub> = 250uA, referenced to 25 °C	-	0.4	-	V/°C
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V	-	-	10	uA
		V <sub>DS</sub> = 480V, T <sub>C</sub> = 125 °C	-	-	100	uA
I <sub>GSS</sub>	Gate-Source Leakage, Forward	V <sub>GS</sub> = 30V, V <sub>DS</sub> = 0V	-	-	100	nA
	Gate-source Leakage, Reverse	V <sub>GS</sub> = -30V, V <sub>DS</sub> = 0V	-	-	-100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250uA	2.0	-	4.0	V
R <sub>DS(ON)</sub>	Static Drain-Source On-state Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5A	-	8.5	11.5	Ω
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25V, f = 1MHz	-	174	340	pF
C <sub>oss</sub>	Output Capacitance		-	185	370	
C <sub>rss</sub>	Reverse Transfer Capacitance		-	80	160	
<b>Dynamic Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> = 300V, I <sub>D</sub> = 1.0A, R <sub>G</sub> = 25Ω * see fig. 13. (Note 4, 5)	-	15	35	ns
t <sub>r</sub>	Rise Time		-	75	140	
t <sub>d(off)</sub>	Turn-off Delay Time		-	30	60	
t <sub>f</sub>	Fall Time		-	35	60	
Q <sub>g</sub>	Total Gate Charge		V <sub>DS</sub> = 480V, V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.0A	-	7.5	
Q <sub>gs</sub>	Gate-Source Charge	-		1	-	
Q <sub>gd</sub>	Gate-Drain Charge(Miller Charge)	* see fig. 12. (Note 4, 5)		-	3	-

## Source-Drain Diode Ratings and Characteristics

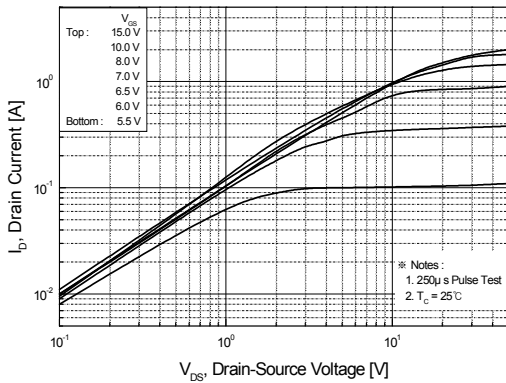
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit.
I <sub>S</sub>	Continuous Source Current	Integral Reverse p-n Junction Diode in the MOSFET	-	-	1.0	A
I <sub>SM</sub>	Pulsed Source Current		-	-	4.0	
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> = 1.0A, V <sub>GS</sub> = 0V	-	-	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>S</sub> = 1.0A, V <sub>GS</sub> = 0V, di <sub>F</sub> /dt = 100A/us	-	420	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	0.42	-	uC

### \* NOTES

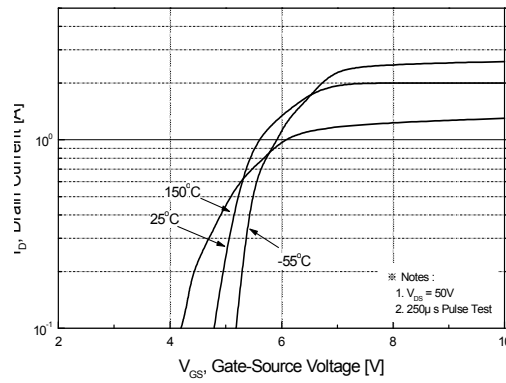
1. Repeativity rating : pulse width limited by junction temperature
2. L = 95mH, I<sub>AS</sub> = 1.0A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 50Ω, Starting T<sub>J</sub> = 25°C
3. I<sub>SD</sub> ≤ 1.0, di/dt ≤ 300A/us, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C
4. Pulse Test : Pulse Width ≤ 300us, Duty Cycle ≤ 2%
5. Essentially independent of operating temperature.

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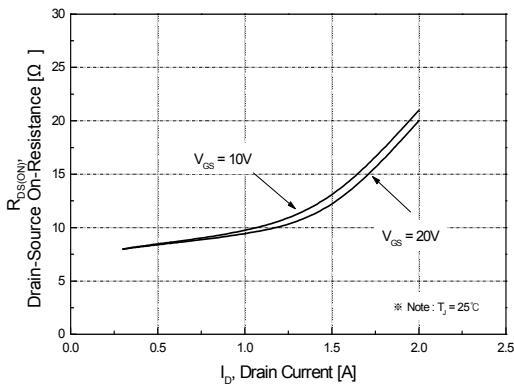
**Fig 1. On-State Characteristics**



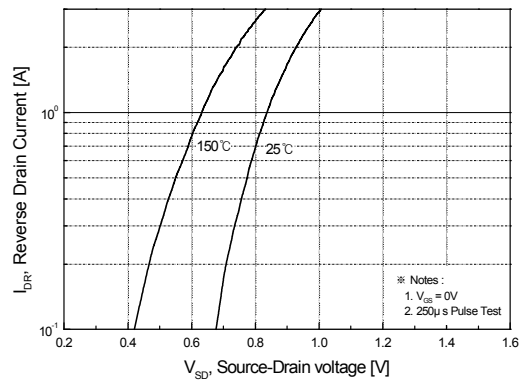
**Fig 2. Transfer Characteristics**



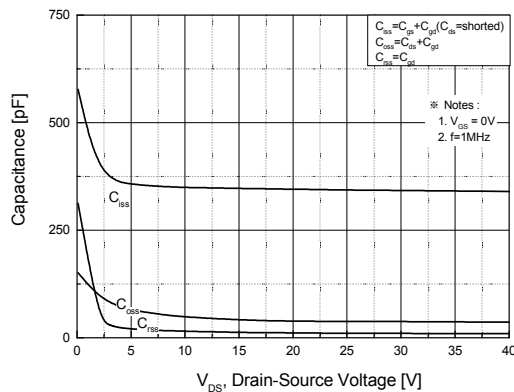
**Fig 3. On Resistance Variation vs. Drain Current and Gate Voltage**



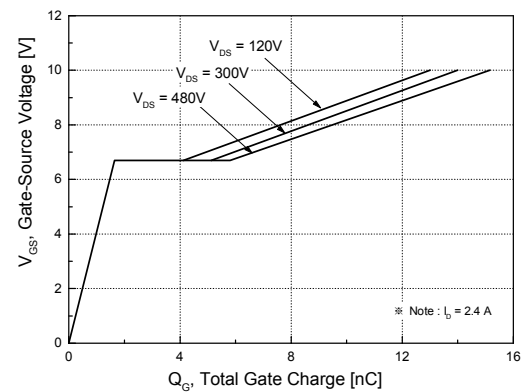
**Fig 4. On State Current vs. Allowable Case Temperature**



**Fig 5. Capacitance Characteristics (Non-Repetitive)**

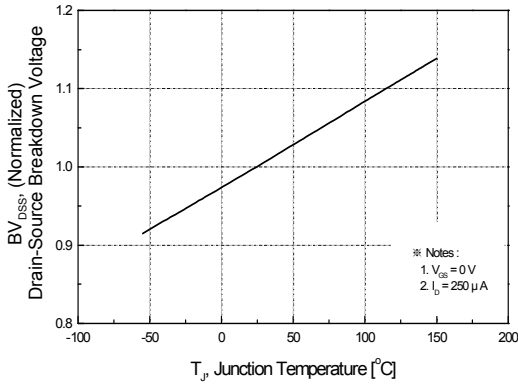


**Fig 6. Gate Charge Characteristics**

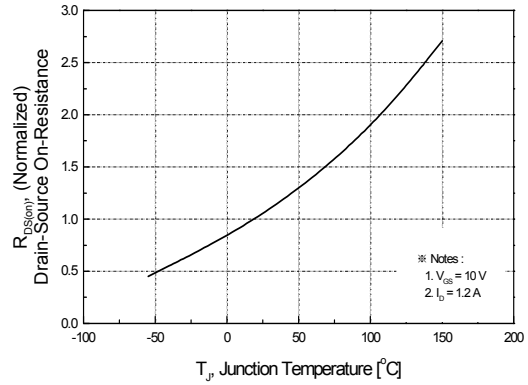


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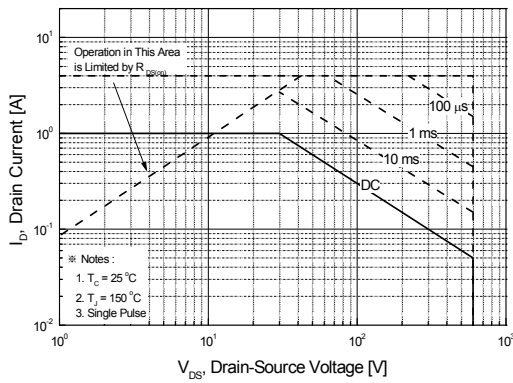
**Fig 7. Breakdown Voltage Variation vs. Junction Temperature**



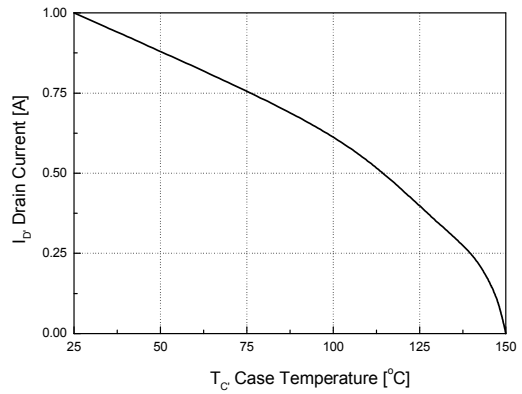
**Fig 8. On-Resistance Variation vs. Junction Temperature**



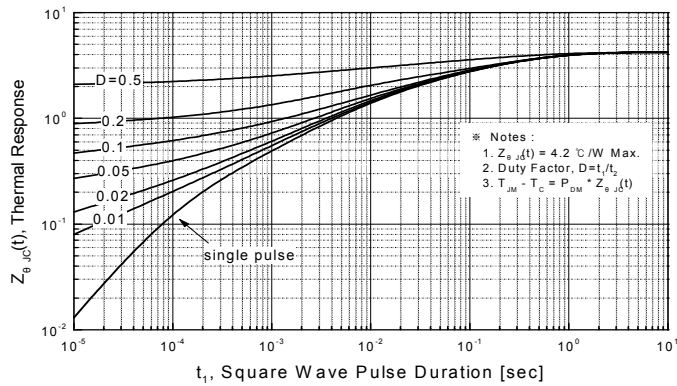
**Fig 9. Maximum Safe Operating Area**



**Fig 10. Maximum Drain Current vs. Case Temperature**



**Fig 11. Transient Thermal Response Curve**



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Fig. 12. Gate Charge Test Circuit & Waveforms

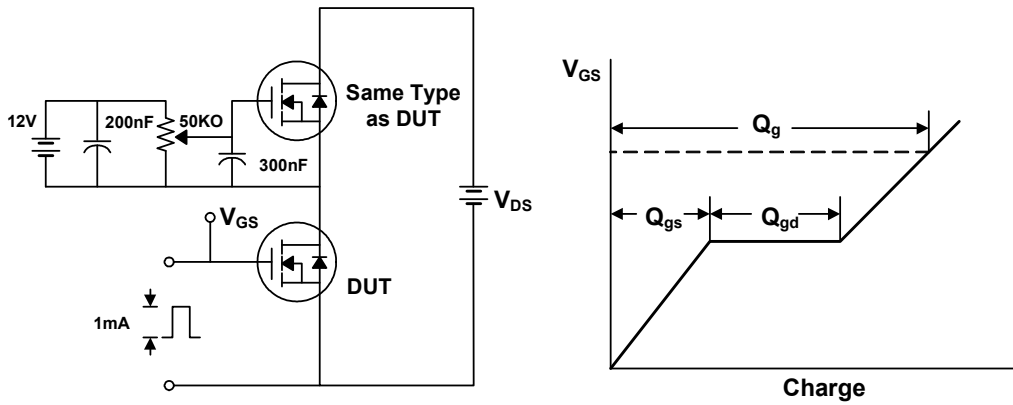


Fig 13. Switching Time Test Circuit & Waveforms

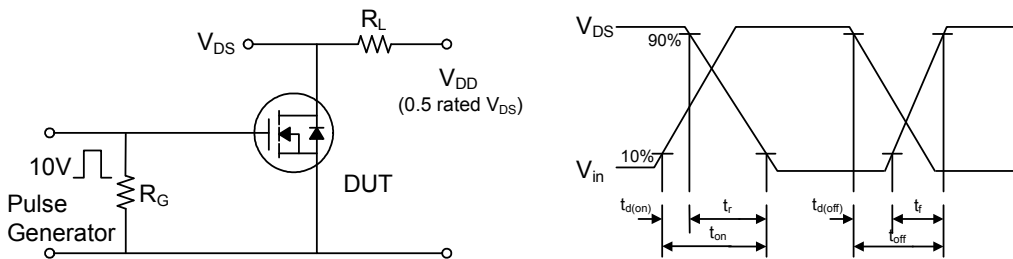
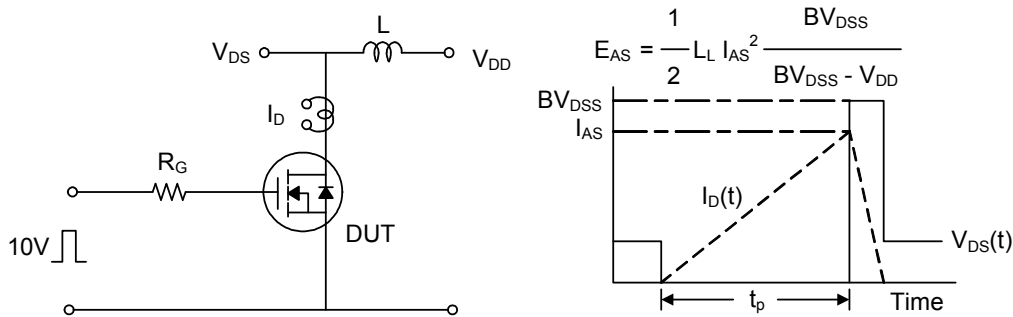
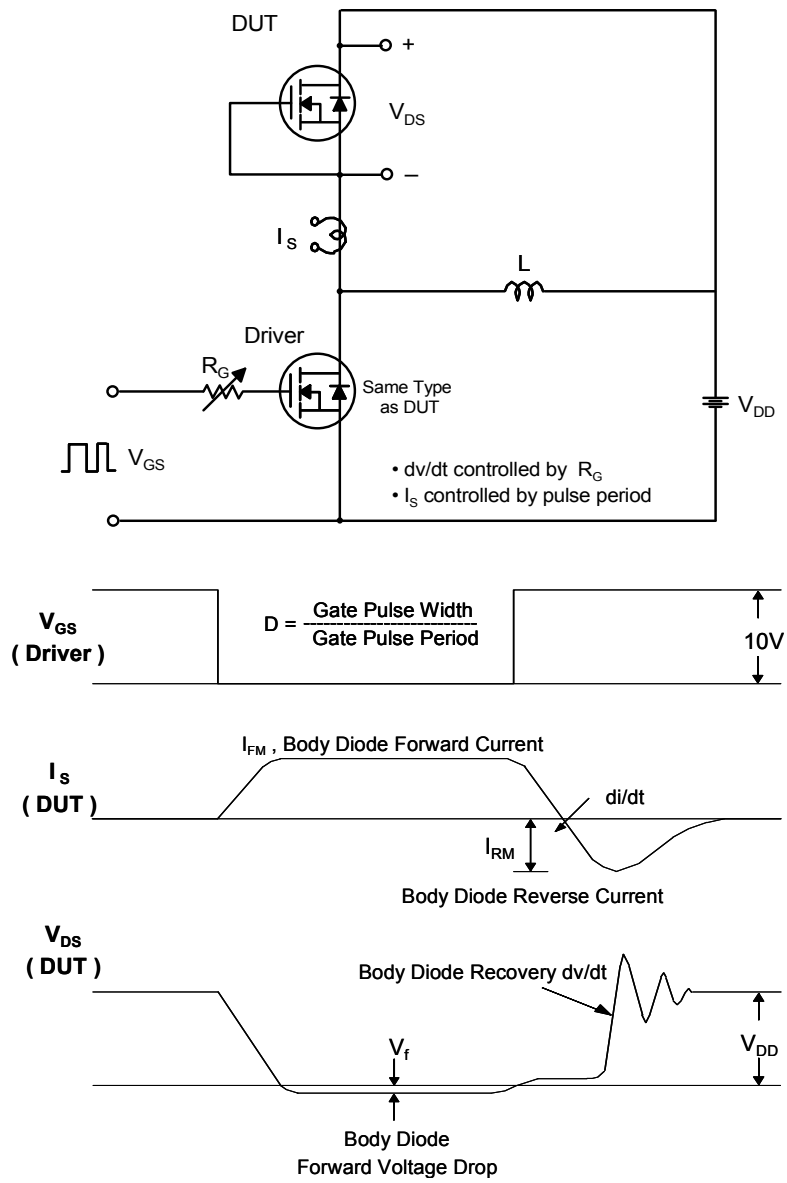


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms



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Fig. 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



**DFU1N60****TO-251(I-PAK) Package Dimension**

Dim.	mm			Inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	5.90	6.10	6.3	0.232	0.240	0.248
B	1.00	1.20	1.40	0.039	0.047	0.055
C	0.60	0.80	1.00	0.024	0.031	0.039
D	7.10	7.3	7.50	0.280	0.287	0.295
E	0.70	0.8	0.90	0.028	0.031	0.035
F	2.10	2.3	2.50	0.083	0.091	0.098
G	0.79	0.89	0.99	0.031	0.035	0.039
H	0.40	0.50	0.60	0.016	0.020	0.024
I	0.92	1.02	1.12	0.036	0.040	0.044
J	6.40	6.60	6.80	0.252	0.260	0.268
K	5.14	5.34	5.64	0.202	0.210	0.222
L	1.00	1.20	1.40	0.039	0.047	0.055
M		0.96			0.038	
N		2.30			0.091	
O	4.40	4.60	4.80	0.173	0.181	0.189

